

# MOS FIELD EFFECT TRANSISTOR

# 2SK3712

## SWITCHING

## N-CHANNEL POWER MOS FET

### DESCRIPTION

The 2SK3712 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for high voltage applications such as DC/DC converter.

### FEATURES

- High voltage:  $V_{DSS} = 250$  V
- Gate voltage rating:  $\pm 30$  V
- Low on-state resistance  
 $R_{DS(on)} = 0.58 \Omega$  MAX. ( $V_{GS} = 10$  V,  $I_D = 4.5$  A)
- Low  $C_{iss}$ :  $C_{iss} = 450$  pF TYP. ( $V_{DS} = 10$  V,  $I_D = 0$  A)
- Built-in gate protection diode
- TO-251/TO-252 package

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ )

|  |                |             |                  |
|--|----------------|-------------|------------------|
| Drain to Source Voltage ( $V_{GS} = 0$ V)            | $V_{DSS}$      | 250         | V                |
| Gate to Source Voltage ( $V_{DS} = 0$ V)             | $V_{GSS}$      | $\pm 30$    | V                |
| Drain Current (DC) ( $T_C = 25^\circ\text{C}$ )      | $I_{D(DC)}$    | $\pm 9.0$   | A                |
| Drain Current (pulse) <sup>Note1</sup>               | $I_{D(pulse)}$ | $\pm 27$    | A                |
| Total Power Dissipation ( $T_C = 25^\circ\text{C}$ ) | $P_{T1}$       | 40          | W                |
| Total Power Dissipation ( $T_A = 25^\circ\text{C}$ ) | $P_{T2}$       | 1.0         | W                |
| Channel Temperature                                  | $T_{ch}$       | 150         | $^\circ\text{C}$ |
| Storage Temperature                                  | $T_{stg}$      | -55 to +150 | $^\circ\text{C}$ |
| Single Avalanche Current <sup>Note2</sup>            | $I_{AS}$       | 9           | A                |
| Single Avalanche Energy <sup>Note2</sup>             | $E_{AS}$       | 8.1         | mJ               |
| Repetitive Avalanche Current <sup>Note3</sup>        | $I_{AR}$       | 9           | A                |
| Repetitive Pulse Avalanche Energy <sup>Note3</sup>   | $E_{AR}$       | 8.1         | mJ               |

**Notes 1.**  $PW \leq 10 \mu\text{s}$ , Duty cycle  $\leq 1\%$

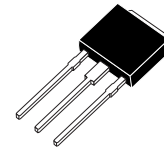
**2.** Starting  $T_{ch} = 25^\circ\text{C}$ ,  $V_{DD} = 125$  V,  $R_G = 25 \Omega$ ,  $V_{GS} = 20 \rightarrow 0$  V,  $L = 100 \mu\text{H}$

**3.**  $T_{ch(peak)} \leq 150^\circ\text{C}$ ,  $L = 100 \mu\text{H}$

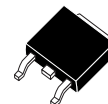
### ★ ORDERING INFORMATION

| PART NUMBER | PACKAGE        |
|-------------|----------------|
| 2SK3712     | TO-251 (MP-3)  |
| 2SK3712-Z   | TO-252 (MP-3Z) |

(TO-251)



(TO-252)



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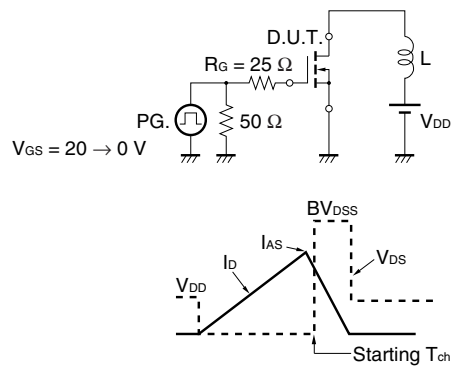
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**ELECTRICAL CHARACTERISTICS (TA = 25°C)**

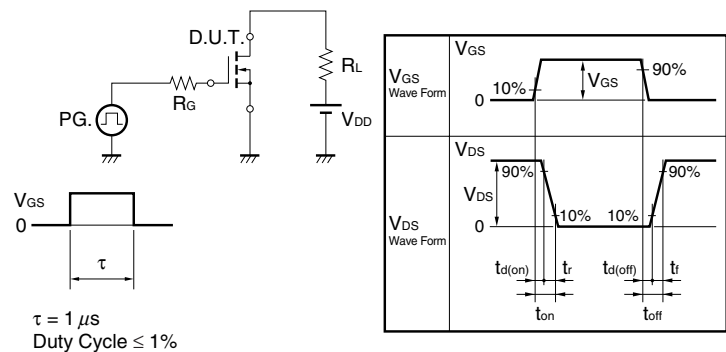
| CHARACTERISTICS                                     | SYMBOL        | TEST CONDITIONS                                 | MIN. | TYP. | MAX.     | UNIT          |
|---|---------------|---|------|------|----------|---------------|
| Zero Gate Voltage Drain Current                     | $I_{DSS}$     | $V_{DS} = 250\text{ V}, V_{GS} = 0\text{ V}$    |      |      | 10       | $\mu\text{A}$ |
| Gate Leakage Current                                | $I_{GSS}$     | $V_{GS} = \pm 30\text{ V}, V_{DS} = 0\text{ V}$ |      |      | $\pm 10$ | $\mu\text{A}$ |
| Gate Cut-off Voltage                                | $V_{GS(off)}$ | $V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$       | 2.5  | 3.5  | 4.5      | V             |
| Forward Transfer Admittance <sup>Note</sup>         | $ y_{fs} $    | $V_{DS} = 10\text{ V}, I_D = 4.5\text{ A}$      | 3    | 6    |          | S             |
| Drain to Source On-state Resistance <sup>Note</sup> | $R_{DS(on)}$  | $V_{GS} = 10\text{ V}, I_D = 4.5\text{ A}$      |      | 0.45 | 0.58     | $\Omega$      |
| Input Capacitance                                   | $C_{iss}$     | $V_{DS} = 10\text{ V}$                          |      | 450  |          | pF            |
| Output Capacitance                                  | $C_{oss}$     | $V_{GS} = 0\text{ V}$                           |      | 100  |          | pF            |
| Reverse Transfer Capacitance                        | $C_{rss}$     | $f = 1\text{ MHz}$                              |      | 40   |          | pF            |
| Turn-on Delay Time                                  | $t_{d(on)}$   | $V_{DD} = 125\text{ V}, I_D = 4.5\text{ A}$     |      | 8    |          | ns            |
| Rise Time   | $t_r$         | $V_{GS} = 10\text{ V}$                          |      | 8    |          | ns            |
| Turn-off Delay Time                                 | $t_{d(off)}$  | $R_G = 0\ \Omega$                               |      | 21   |          | ns            |
| Fall Time   | $t_f$         |   |      | 6    |          | ns            |
| Total Gate Charge                                   | $Q_G$         | $V_{DD} = 200\text{ V}$                         |      | 14   |          | nC            |
| Gate to Source Charge                               | $Q_{GS}$      | $V_{GS} = 10\text{ V}$                          |      | 3    |          | nC            |
| Gate to Drain Charge                                | $Q_{GD}$      | $I_D = 9.0\text{ A}$                            |      | 7    |          | nC            |
| Body Diode Forward Voltage <sup>Note</sup>          | $V_{F(S-D)}$  | $I_F = 9\text{ A}, V_{GS} = 0\text{ V}$         |      | 0.9  | 1.5      | V             |
| Reverse Recovery Time                               | $t_{rr}$      | $I_F = 9\text{ A}, V_{GS} = 0\text{ V}$         |      | 150  |          | ns            |
| Reverse Recovery Charge                             | $Q_{rr}$      | $di/dt = 100\text{ A}/\mu\text{s}$              |      | 630  |          | nC            |

**Note** Pulsed

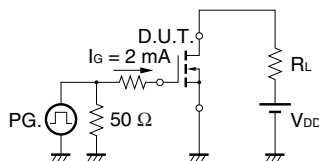
**TEST CIRCUIT 1 AVALANCHE CAPABILITY**



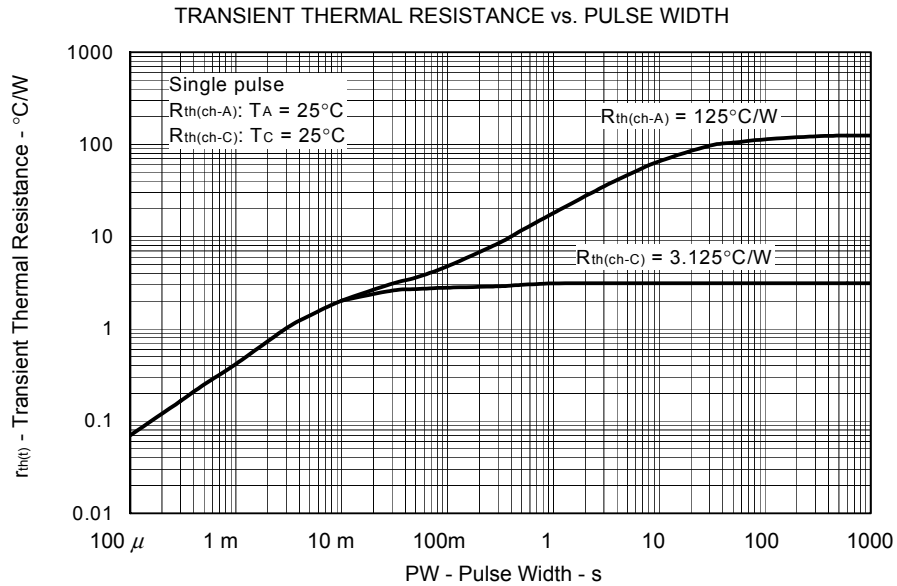
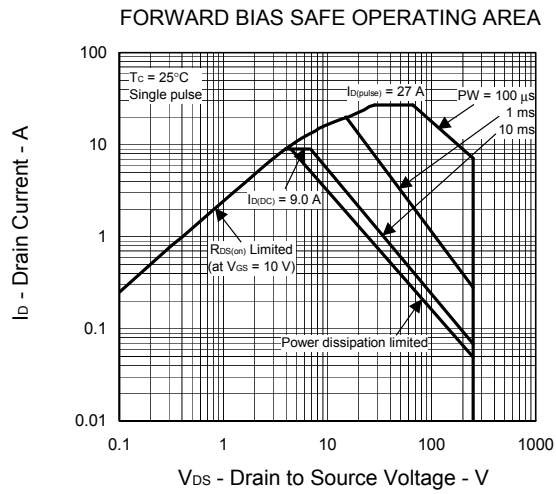
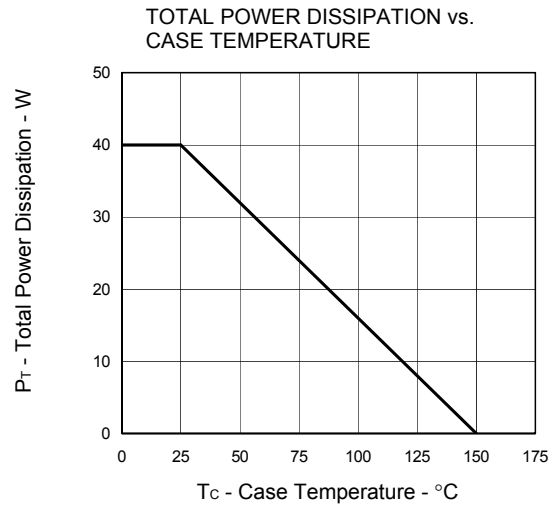
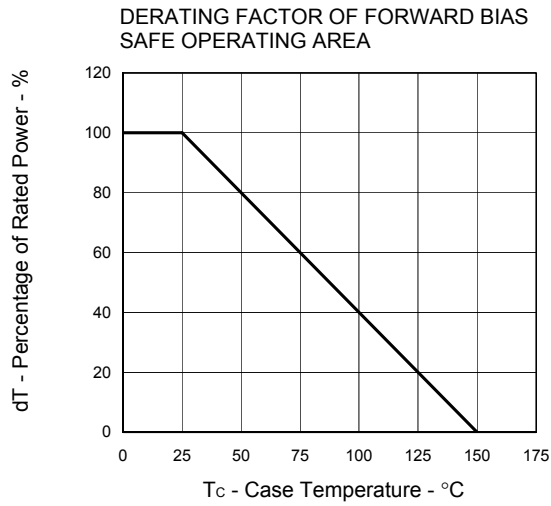
**TEST CIRCUIT 2 SWITCHING TIME**



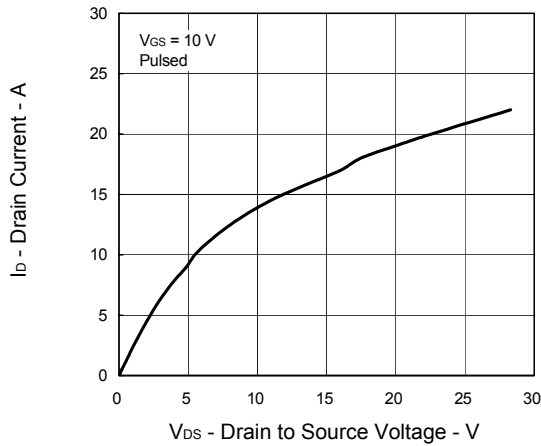
**TEST CIRCUIT 3 GATE CHARGE**



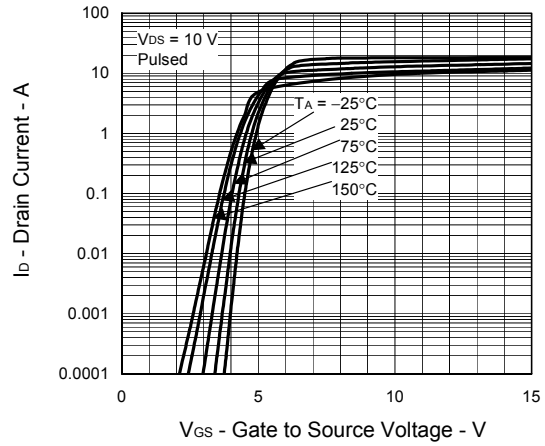
TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)



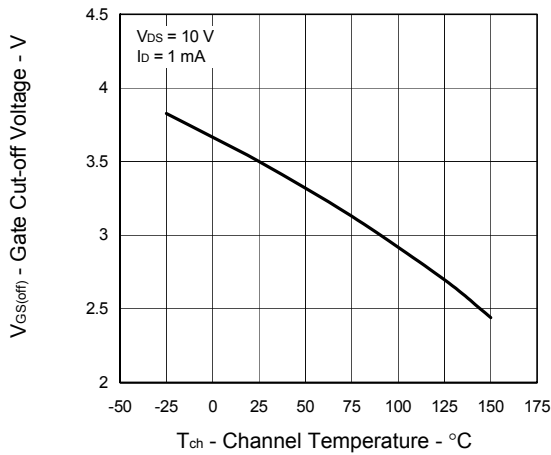
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



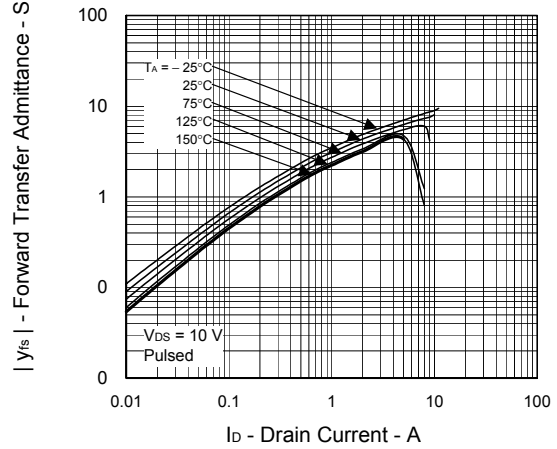
FORWARD TRANSFER CHARACTERISTICS



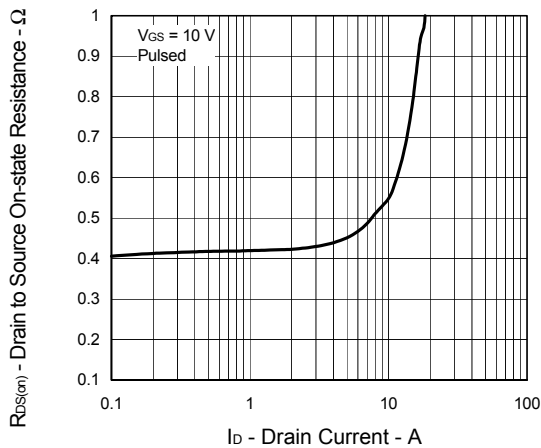
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



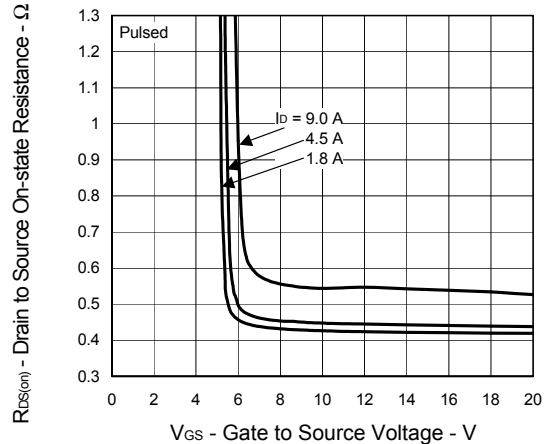
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



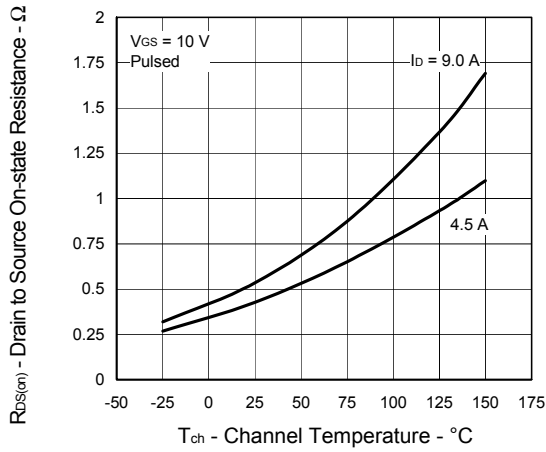
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



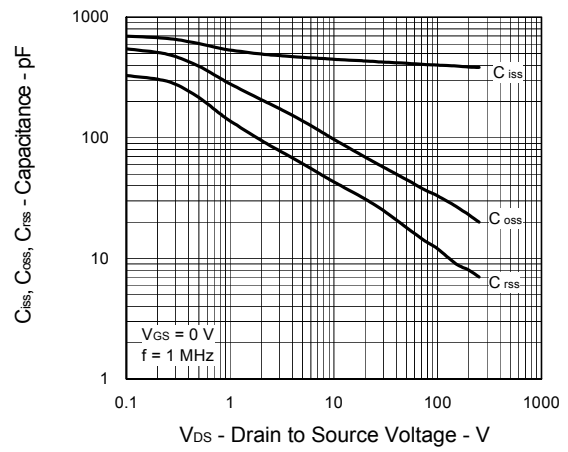
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



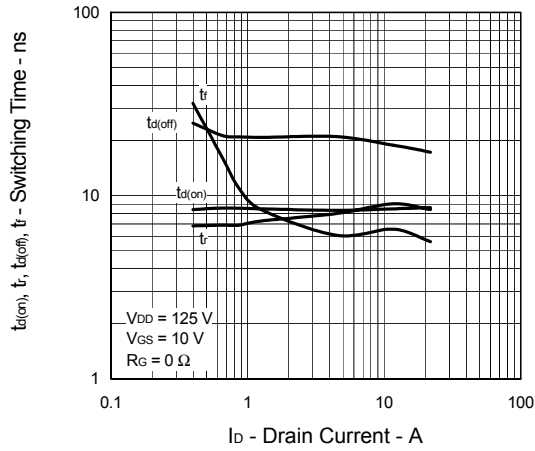
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



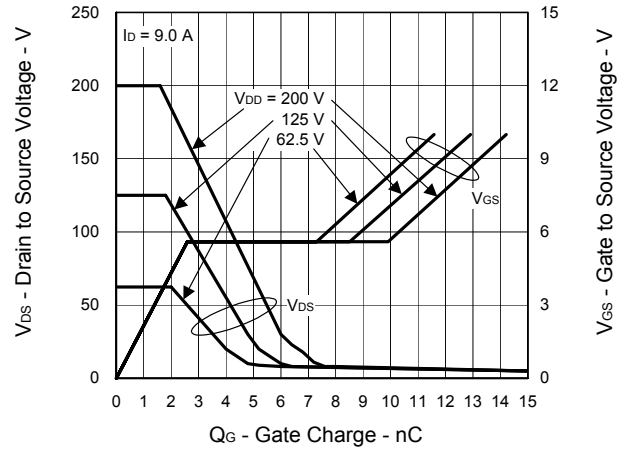
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



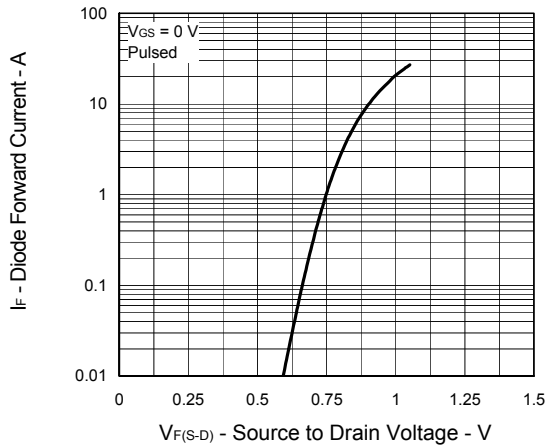
SWITCHING CHARACTERISTICS



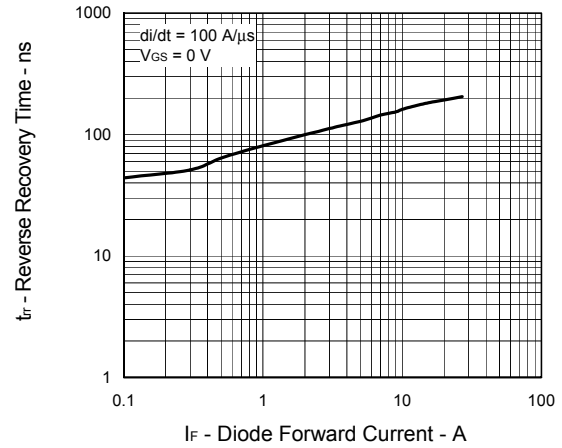
DYNAMIC INPUT/OUTPUT CHARACTERISTICS

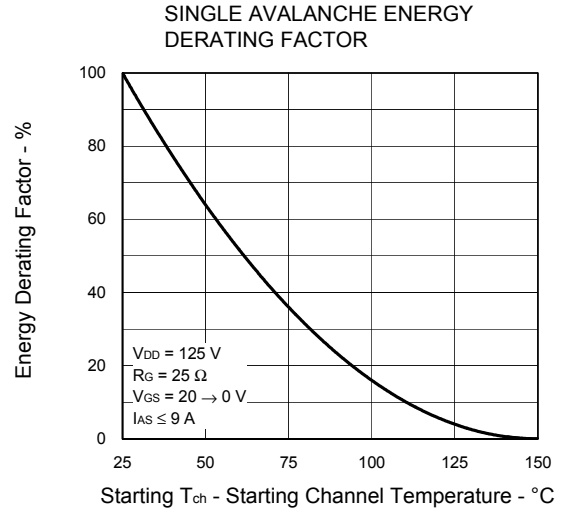
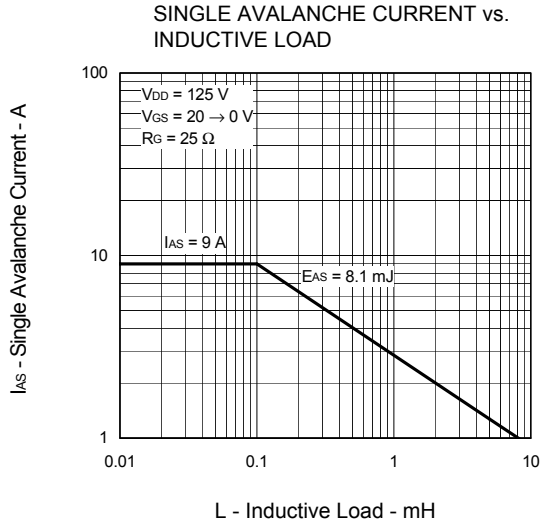


SOURCE TO DRAIN DIODE FORWARD VOLTAGE



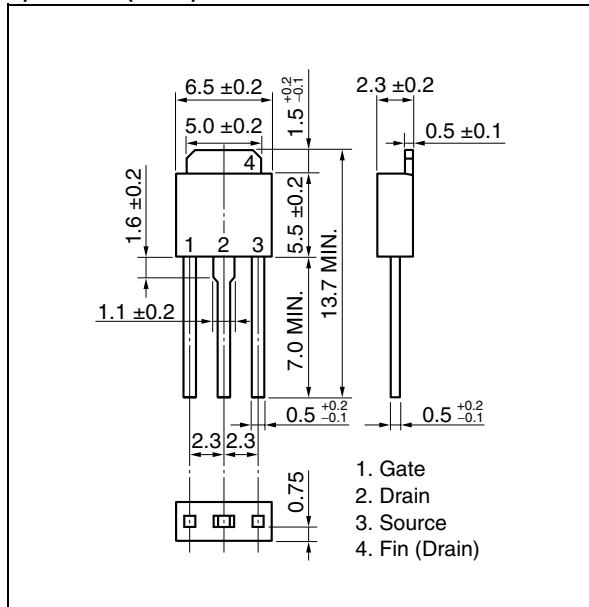
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



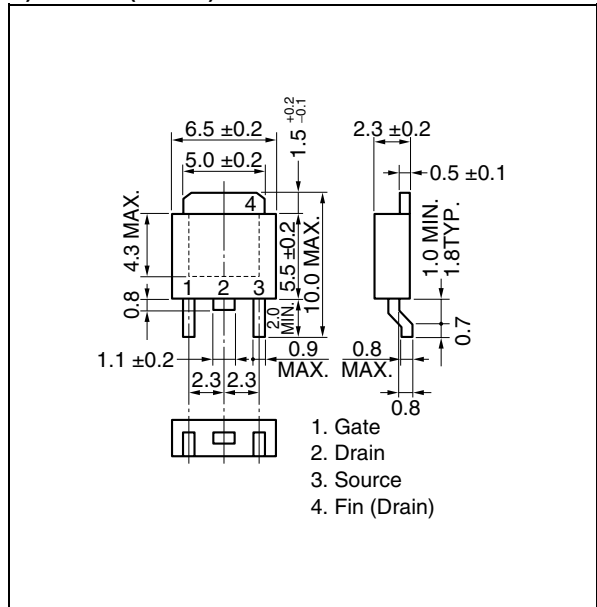


★ PACKAGE DRAWINGS (Unit: mm)

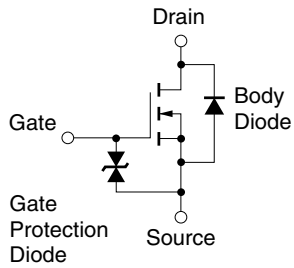
1) TO-251 (MP-3)



2) TO-252 (MP-3Z)



EQUIVALENT CIRCUIT



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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